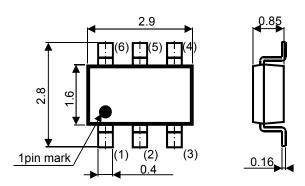


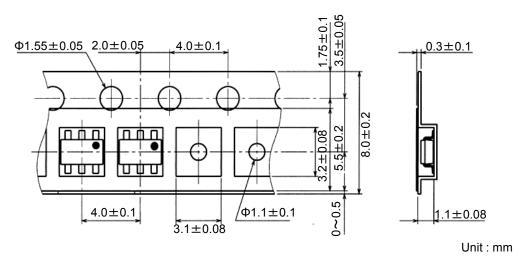
Tape and Packing

			•		
Product	Transistor / MOSFET	Package	SOT-457T (TSMT6)	Type	TCR

1. Components description (Only for reference)



2. Taping dimensions



Unit: mm

Note) Feed holes might be cover with the adhesive tape, but nothing will affect for using by that.

3. Tape and packing specification

3-1. Direction of tape winding

Connection (1), (2) and (3) comes to feeding hole side. The direction shall be one in a reel.

3-2. Cumulative pitch tolerance

The cumulative pitch tolerance of the mold for producing the carrier tape shall be within ± 0.2 mm per 10pitches.

3-3. The minimum radius to bend the carrier tape

Carrier tape shall be flexible enough to protect from no component and damage under a minimum radius of 30mm. However it shall be defined only inside of carrier tape.

3-4. The material of carrier tape

Special carbon paints are coated both sides of polystyrene.

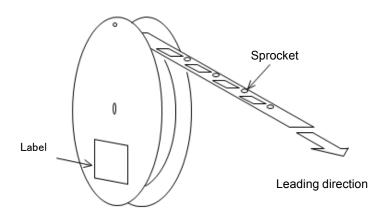
3-5. The material of reel Polystyrene + Carbon

3-6. Failure Rate

	Incidence	Remark	
Continuous missing	0%	Except leader and trail portion	
Discontinuous missing	Max.0.1% / reel	Except leader and trail portion	

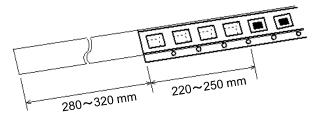
4. Reeling specification

4-1. Leading direction



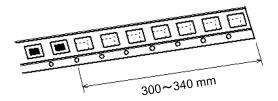
4-2. Leader

Leader tape shall be separated into two parts-an adhesive tape at first part and carrier tape without products.



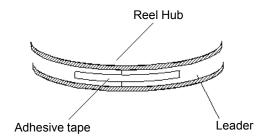
4-3. Trail

Trail tape shall remain with no product and trail tape shall not be stuck directly on a reel.



5. Treatment for end of tape

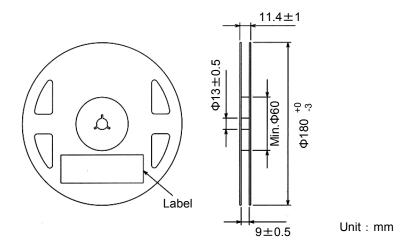
The end of leader tape shall be fixed with the white adhesive tape.



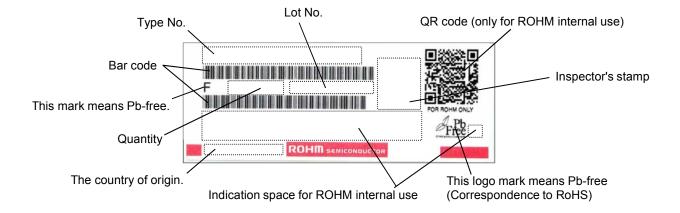
2/4

6. Quantity 3,000 pcs / reel

7. Reel dimensions



8. Marking Each reel shall be legibly marked with the following items.



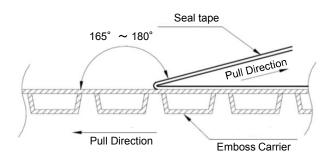
9. Type Product code of taping shall be composed as indicated below.

10. Taping Peeling Strength

Peeling strength: 0.1N~1.0N (If products have stored over our recommended storage condition.)

[Test condition (Based on JIS C 0806-3)]

Pull direction at angle from 165° to 180° and pull the seal tape with the speed of 300 mm/min±10 mm/min.



11. Recommended storage condition

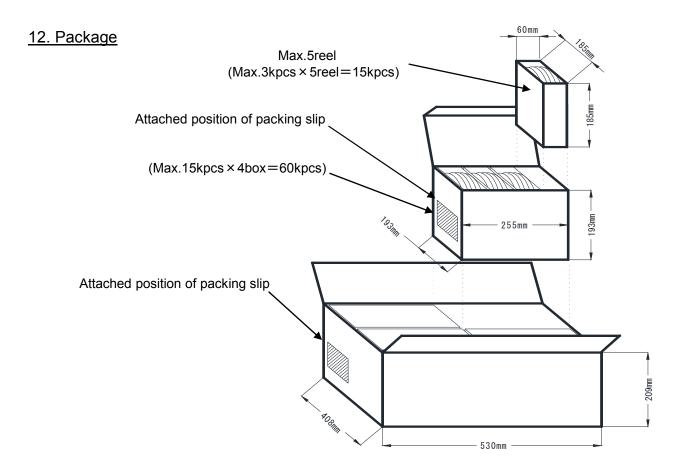
Recommended storage condition:

Temperature 5°C - 40°C, Humidity 30%RH - 80%RH

Recommended storage time period :

- •Dipped SMD products (Sn3Ag0.5Cu) : One year after production
- •Plated SMD products (Sn2Cu or Sn100%) : Five years after production

Notes) It is strongly recommended to confirm solderability before using products of which storage time is exceeding recommended storage time period.



Notes

- 1) The information contained herein is subject to change without notice.
- Before you use our Products, please contact our sales representative and verify the latest specifications:
- 3) Although ROHM is continuously working to improve product reliability and quality, semiconductors can break down and malfunction due to various factors. Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Poducts beyond the rating specified by ROHM.
- 4) Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.
- 5) The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.
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